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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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### DATA SHEET



### HETERO JUNCTION FIELD EFFECT TRANSISTOR

NE3517S03

# K-BAND SUPER LOW NOISE AMPLIFIER N-CHANNEL GaAs HJ-FET

#### **FEATURES**

- Super low noise figure, high associated gain
   NF = 0.7 dB TYP., G<sub>a</sub> = 13.5 dB TYP. @ f = 20 GHz
- K-band Micro-X plastic (S03) package

### **APPLICATIONS**

- 20 GHz band DBS LNB
- · Other K-band communication systems

### **ORDERING INFORMATION**

Part Number	Order Number	Package	Quantity	Marking	Supplying Form
NE3517S03-T1C	NE3517S03-T1C-A	S03 (Pb-Free)	2 kpcs/reel	E	• 8 mm wide embossed taping
NE3517S03-T1D	NE3517S03-T1D-A		10 kpcs/reel		Pin 4 (Gate) faces the perforation side     of the tape

**Remark** To order evaluation samples, please contact your nearby sales office.

Part number for sample order: NE3517S03

### ABSOLUTE MAXIMUM RATINGS ( $T_A = +25^{\circ}C$ )

Parameter	Symbol	Ratings	Unit
Drain to Source Voltage	V <sub>DS</sub>	4	٧
Gate to Source Voltage	V <sub>GS</sub>	-3	٧
Drain Current	lσ	loss	mA
Gate Current	lg	100	μΑ
Total Power Dissipation	Ptot Note	165	mW
Channel Temperature	Tch	+125	ç
Storage Temperature	T <sub>stg</sub>	-65 to +125	°C

Note Mounted on 1.08 cm<sup>2</sup> × 1.0 mm (t) glass epoxy PCB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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### RECOMMENDED OPERATING CONDITIONS ( $T_A = +25$ °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Drain to Source Voltage	V <sub>DS</sub>	1	2	3	V
Drain Current	lσ	5	10	15	mA
Input Power	Pin	_	_	0	dBm

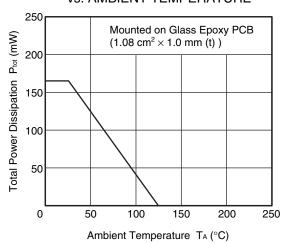
### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = +25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Gate to Source Leak Current	Igso	V <sub>G</sub> S = -3 V	1	0.5	10	μΑ
Saturated Drain Current	IDSS	V <sub>DS</sub> = 2 V, V <sub>GS</sub> = 0 V	25	40	70	mA
Gate to Source Cutoff Voltage	VGS (off)	$V_{DS} = 2 \text{ V}, I_{D} = 100 \ \mu\text{A}$	-0.2	-0.7	-1.5	٧
Transconductance	<b>g</b> m	V <sub>DS</sub> = 2 V, I <sub>D</sub> = 10 mA	40	55	-	mS
Noise Figure	NF	V <sub>DS</sub> = 2 V, I <sub>D</sub> = 10 mA, f = 20 GHz	_	0.7	1.0	dB
Associated Gain	Ga		11.0	13.5	-	dB

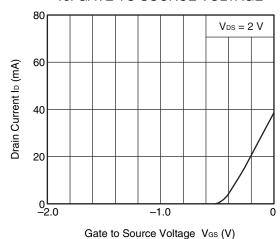
2

### TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

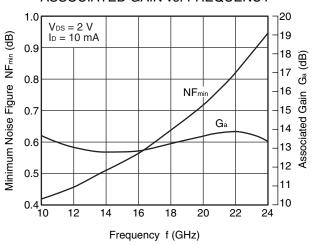
## TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



## DRAIN CURRENT vs. GATE TO SOURCE VOLTAGE

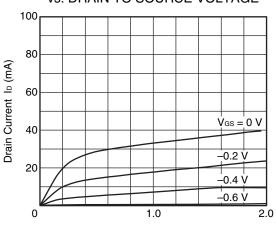


### MINIMUM NOISE FIGURE, ASSOCIATED GAIN vs. FREQUENCY



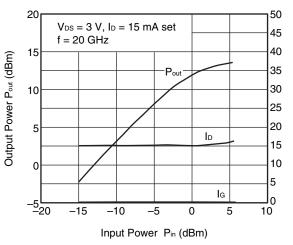
### Remark The graphs indicate nominal characteristics.

## DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



Drain to Source Voltage VDS (V)

## OUTPUT POWER, DRAIN CURRENT, GATE CURRENT vs. INPUT POWER



Drain Current Io (mA), Gate Current Io (mA)

NEC NE3517S03

### **S-PARAMETERS**

S-parameters and noise parameters are provided on our Web site in a format (S2P) that enables the direct import of the parameters to microwave circuit simulators without the need for keyboard inputs.

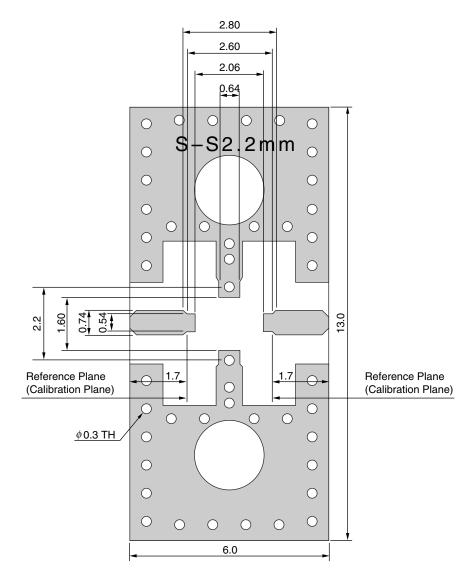
Click here to download S-parameters.

 $[\mathsf{RF} \ \mathsf{and} \ \mathsf{Microwave}] \to [\mathsf{Device} \ \mathsf{Parameters}]$ 

URL http://www.necel.com/microwave/en/

4

### RF MEASURING LAYOUT PATTERN (REFERENCE ONLY) (UNIT: mm)



RT/duroid 5880/ROGERS

t = 0.254 mm

 $\varepsilon r = 2.20$ 

tan delta = 0.0009 @ 10 GHz

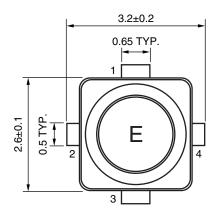
Au-flash plate

5

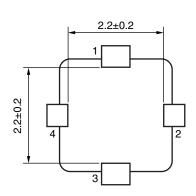
### **PACKAGE DIMENSIONS**

S03 (UNIT: mm)

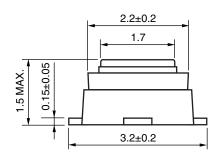
(Top View)



(Bottom View)



(Side View)



### **PIN CONNECTIONS**

- 1. Source
- 2. Drain
- 3. Source
- 4. Gate



### RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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NEC NE3517S03

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GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.